

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of  
John Liu et al. *10/072365*  
Serial No. (not yet received) *2-7-02*  
Filed (filed concurrently herewith) *2-7-02*  
For High Toughness Plate Alloy  
for Aerospace Applications

*1740*  
*WILKINS*

Attorney Docket *97-2739*

SAH  
#2  
3-8-02  
JC978 U.S. PRO  
10/072365  
02/07/02  


**INFORMATION DISCLOSURE STATEMENT**

I hereby certify that this correspondence is being Express  
Mailed (EL740322731US) to the Assistant Commissioner  
for Patents, Washington, D.C. 20231 on February 7, 2002.

*Julie W. Meder*  
Julie W. Meder, Reg. No. 36216

Date of Signature: February 7, 2002

Assistant Commissioner for Patents

Washington, D.C. 20231

Sir:

In accordance with 37 CFR 1.97(b), the Information Disclosure Statement  
submitted herewith is being filed within three months of the filing date of the application  
or before the mailing date of a first Office action on the merits, whichever event occurs  
last.

Copies of the references cited in the attached Disclosure Statement are  
enclosed.

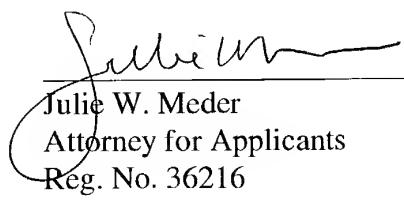
This citation is made solely for the purpose of giving the patent Examiner full and convenient opportunity to make an independent review of these references during the examination of this application. No representation of any nature is made or intended by this disclosure.



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PATENT TRADEMARK OFFICE

Respectfully submitted,

  
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Julie W. Meder  
Attorney for Applicants  
Reg. No. 36216